

MATERIALS SCIENCE, INC.

Vacuum & Thin Film Technology

Press Release

FOR IMMEDIATE RELEASE

1 July 2023
San Diego, CA

Materials Science, Inc. Relocates Corporate Headquarters, Ownership & Management Changes

Materials Science, Inc. a supplier of sputtering sources, power supplies and related equipment is relocating its headquarters to its Colorado manufacturing location of several decades from San Diego, California as its founder John Miller retires. The transition begins in July, 2023. Patrick Manley, is assuming management of the company, adding to his decades long role as Materials Science, Inc. manufacturing and engineering manager. John will remain as an active advisor and consultant as needed as he fades off into the sunset. The rest of the team remains.

All of Materials Science customers and products, some dating to 1989, will continue to be supported without interruption.

NSA Scientific, Inc. (Patrick Manley – President) will assume the intellectual property, customer base and Materials Science, Inc. assets, but continue to operate under the dba Materials Science identity to maintain continuity. The transition will be seamless and all contracts, warranties and purchase orders placed prior to July, 2023 will continue to be honored. Individual customers will be notified of any specific legal and financial details that may change.

The new, company contact information:

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Longmont, CO 80503
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For More Information Contact:

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About Materials Science, Inc.:

Materials Science, Inc. is a privately held California Corporation founded in 1992. The company manufactures magnetron sputtering sources and related products. Markets served include magnetic and optical storage media, semiconductor production, compound semiconductor devices, precision optics, decorative coatings, functional and wear purposes, flexible substrates, MEMS devices, flat panel displays, telecommunication devices, fiber optics and other applications.
